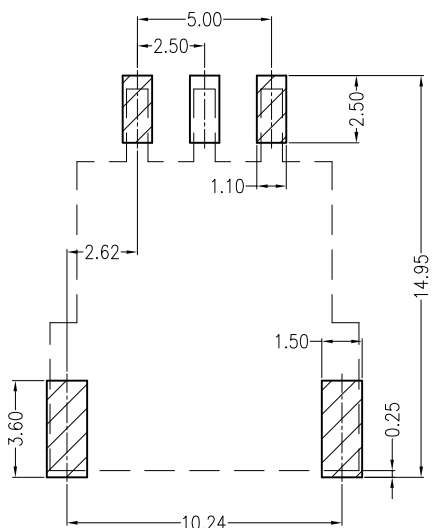
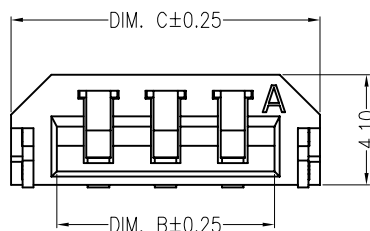
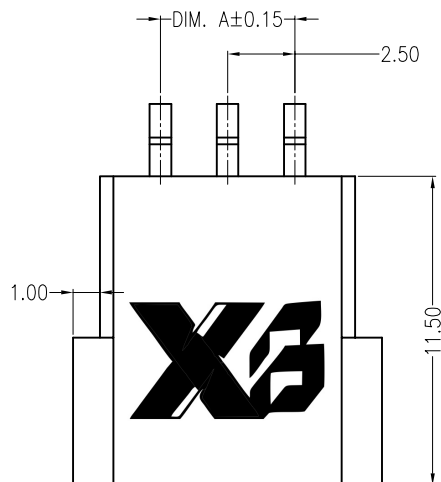
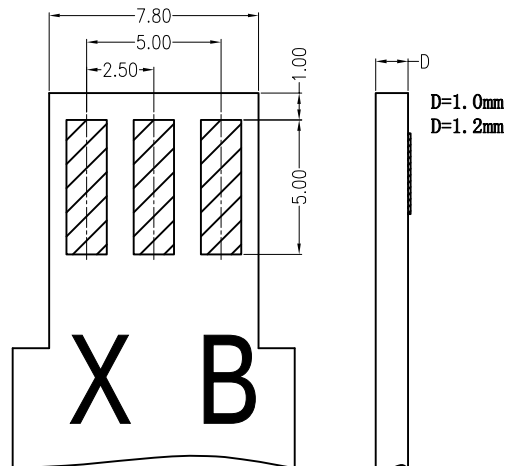
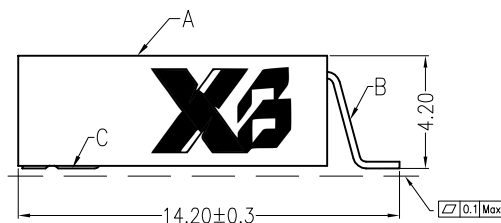




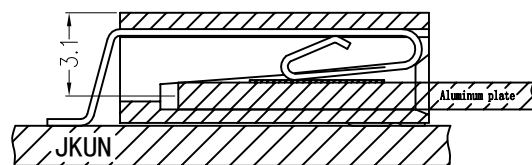
Board Layout



Mating Aluminum plate detail

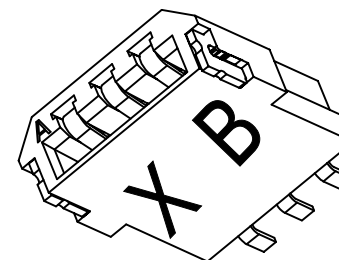


名称	尺寸	DIM=A	DIM=B	DIM=C
L006-02		2.50	5.60	9.00
L006-03		5.00	8.10	11.50



Assembly Layout

REV	ECN No.	DESCRIPTION	DESIGN	DATE
A0		Release	吴丹平	2014.03.18



主要技术参数 Main Specifications

板 厚 (thickness): 1.0mm to 1.2mm
 接触电阻 (Contact resistance): $\leq 20m\Omega$
 绝缘电阻 (Insulation resistance): $\geq 800M\Omega$
 额定电压 (Rated voltage): 250V AC DC
 额定电流 (Rated current): 2.0A AC DC
 耐 电 压 (Withstand Voltage): 800V AC/minute
 温度范围 (Temperature Range): $-25^{\circ}C \sim +105^{\circ}C$

ORDER INFORMATION:

XB- L006-**-F2MB-R	
PART No. _____	PACKAGING: _____
No. FOR Aluminum plate: _____	R=REEL
**	P=PE
PLASTIC MATERIAL: _____	PLATING: _____
F2M=LCP (BEIGE)	B=MATTE Sn

C	SOLDER TAB	2 PCS	Brass	Sn-plated
B	CONTACT	2~3 PCS	PhosphorBronze	MATTE Sn-plated
A	PEDESTAL	1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
东莞市溪榜电子有限公司 Switch Connector DONG GUAN XI BANG ELECTRONICS CO., LTD				
X.±0.5	X.±5'	USE: CUSTOMER		PART NO.:
X.±0.3	X.±2'			L006-**-F2MB-R
.XX±0.25	.XX±1'	APPD: 邵敬和		DWG NO.:
--	--	CHKD: 田 峰		GCCP-0015
⊕	UNITS: mm	DR: 吴丹平		SCALE 1 : 1
				SHEET 1 / 1

TITLE: L006-**-1R
 2.5mmPITCH 90°WAFER SMT TYPE